TEXAS INSTRUMENTS

DAC5675A Evaluation Module

User's Guide

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SLAU080A

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EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM within the input voltage range of 3.3 V.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 60°C. The EVM is designed to operate properly with certain components above 60°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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Chapter 1

Overview

This chapter gives a general overview of the DAC5675A evaluation module (EVM) and provides a general description of the features and functions to be considered while using this module.

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1.1 Purpose

The DAC5675A EVM provides a platform for evaluating the DAC5675A digital-to-analog converter (DAC) under various signal, reference, and supply conditions. This document must be used in combination with the EVM schematic diagram supplied.

1.2 EVM Basic Functions

Digital inputs to the DAC can be provided with either LVDS level inputs through a 60 pin header or CMOS inputs through a 40 pin header. This enables the user to provide high-speed digital data to the DAC5675A.

The analog output from the DAC is provided via SMA connectors. Because of its flexible design the analog output of the DAC5675A can be configured to drive a 50 Ω terminated cable using a 4:1 or 1:1 impedance ratio transformer, or single-ended referred to AV_{DD}.

The EVM allows for different clock configurations. The user can input a differential ECL/PECL or TTL/CMOS level signal, to be used to generate a single-ended or differential clock source. Refer to the clock section for proper configuration and operation.

Power connections to the EVM are via banana jack sockets. Separate sockets are provided for the analog and digital supply.

In addition to the internal bandgap reference provided by the DAC5675A device, options are provided on the EVM to allow external reference to be provided to the DAC.

1.3 Power Requirements

The EVM can be powered directly with a single 3.3-V supply. Provision has been made to allow the EVM to be powered with independent 3.3-V analog and digital supplies to provide higher performance.

Note: Voltage Limits

Exceeding the maximum input voltages can damage EVM components. Under voltage may cause improper operation of some or all of the EVM components.

1.4 DAC5675A EVM Operational Procedure

The DAC5675A EVM can be set up in a variety of configurations to accommodate a specific mode of operation. Before starting evaluation, the user should decide on the configuration and make the appropriate connections or changes. The following setup procedure can be used as a board confidence check:

1) Verify all jumper settings against the schematic jumper list in Tables 1−1 and 1−2:

Table 1−1. Two Pin Jumper List

Jumper	Function	Installed	Removed	Default
W4	Power for LVDS driver	Enables CMOS input circuit	CMOS input circuit is powered down	Installed

Table 1−2. Three Pin Jumper List

Jumper	Function	Location: Pins 1− 2	Location: Pins 2−3	Default
W1	Power down select	Power down mode	Operate mode	2−3
W2	N/A	N/A	N/A	Not Installed
W3	LVDS line driver enable	Outputs 3-state	Outputs enabled	2−3

2) Connect supplies to the EVM as follows:
   3.3 V analog supply to J1 and return to J2.
   3.3 V digital supply to J3 and return to J4.

3) Switch power supplies on.

4) Use a frequency generator with 50-Ω output to input a 400 Mhz, 0V offset, 150-mVpp amplitude sine wave signal into J9 to be used as the DAC clock. The frequency of the clock must be within the specification for the device speed grade.

5) Use a digital test pattern generator with 50 Ω outputs to input 3.3-V CMOS logic level inputs to P2. This data must be synchronized and the same frequency as the DAC input clock.

6) The analog output on SMA connector J8 can now be monitored using a spectrum analyzer.

Chapter 2

PCB Layout and Parts List

This chapter shows the PCB layout of the EVM and lists the components used on the module.

Topic **Page**

2.1 PCB Layout 2-2

2.2 Parts List 2-5

2.1 PCB Layout

Figures 4−1 through 4−6 show the PCB layout for the EVM.

Figure 2−1. Top Layer 1

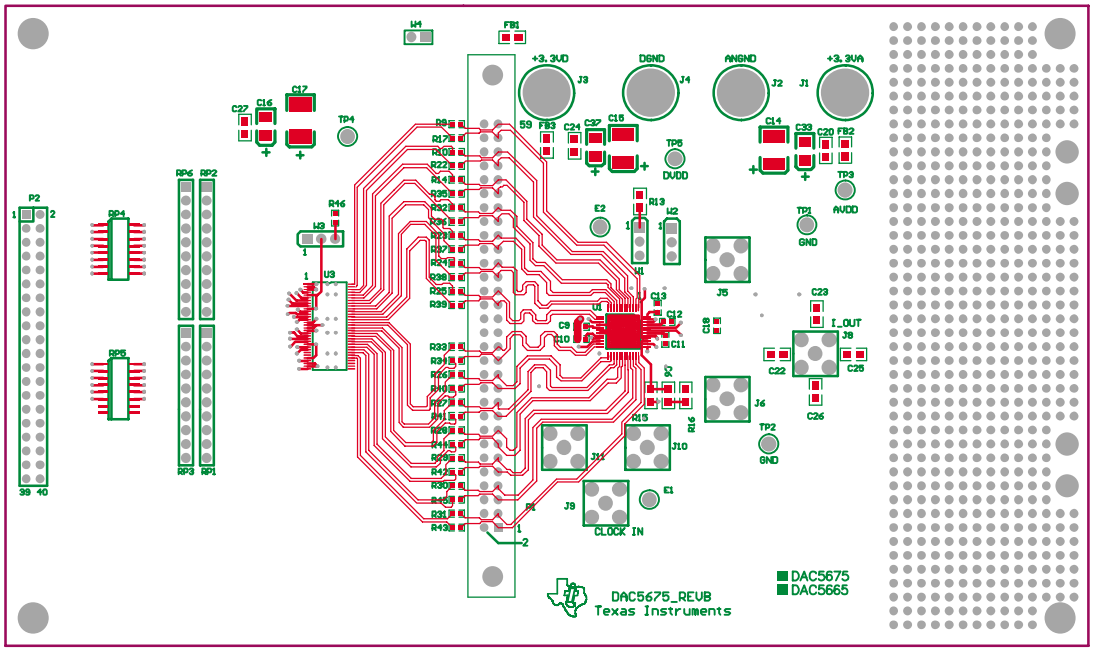


Figure 2−2. Ground Plane 1 Layer 2

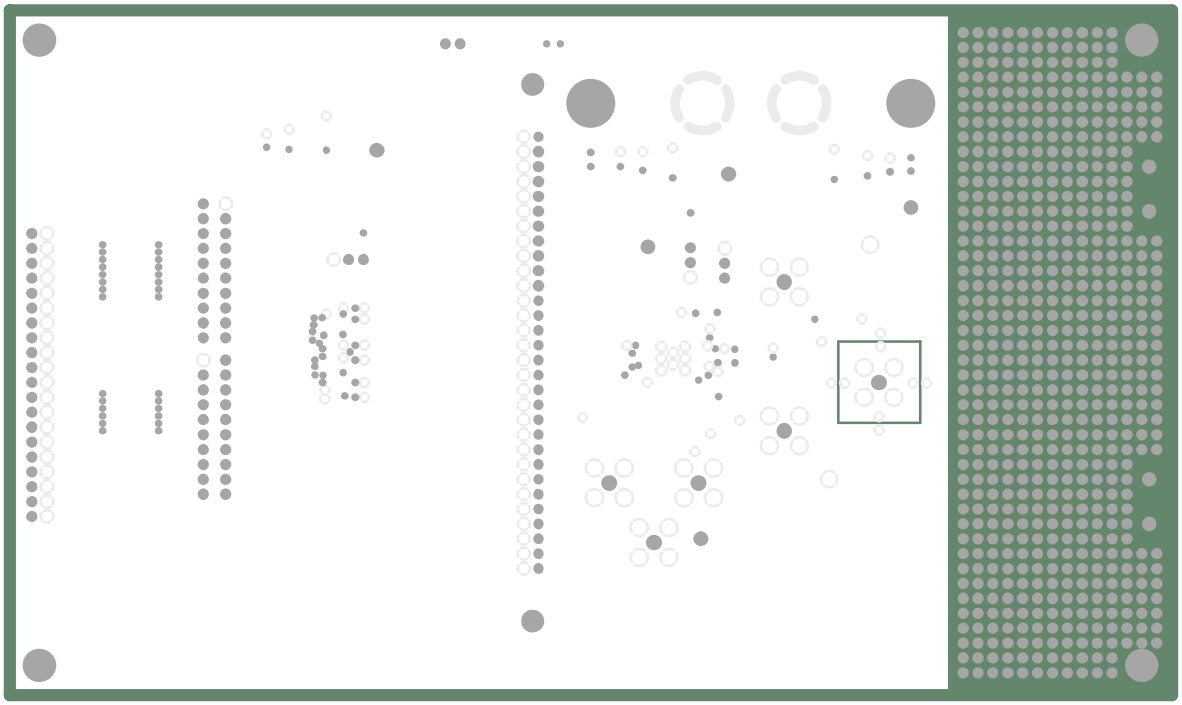


Figure 2−3. AVDD Power Plane Layer 3

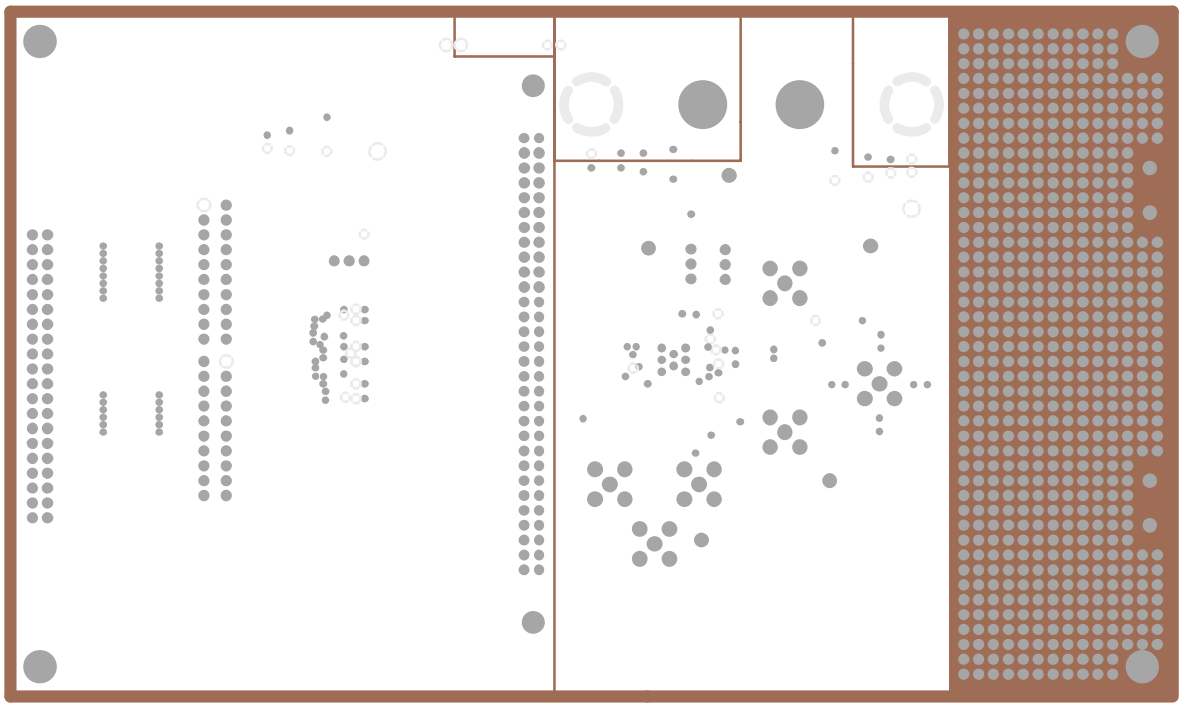


Figure 2−4. DVDD Power Plane Layer 4

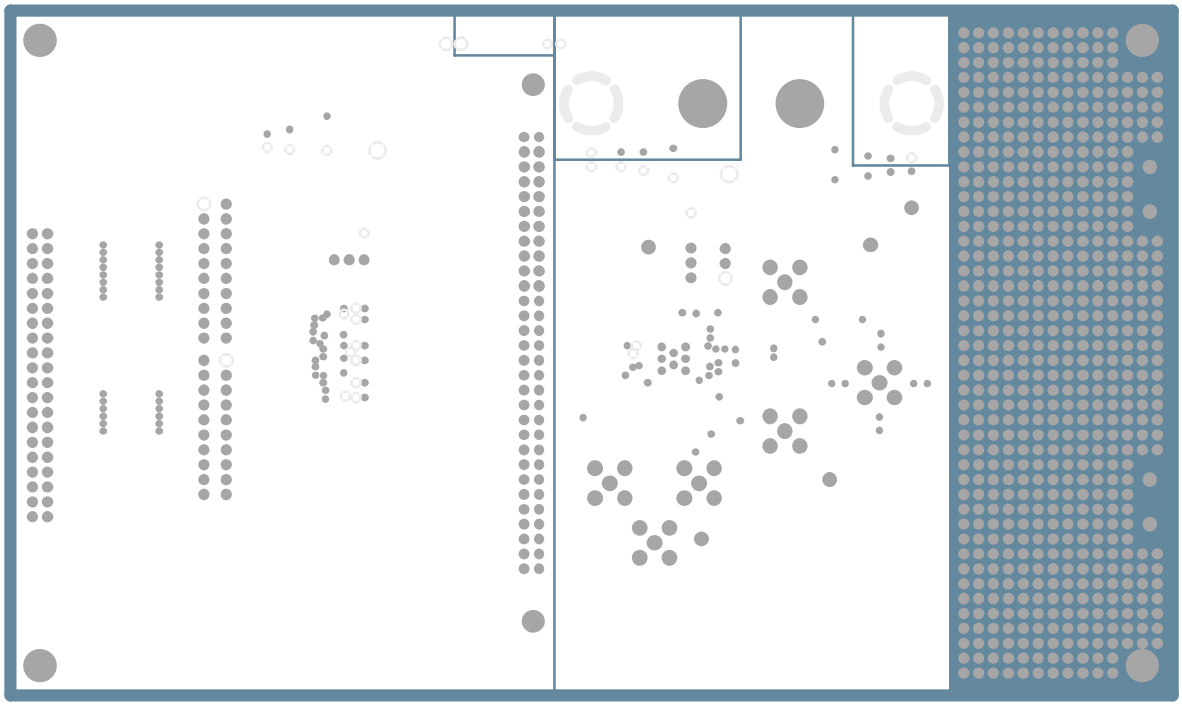


Figure 2−5. Ground Plane 2 Layer 5

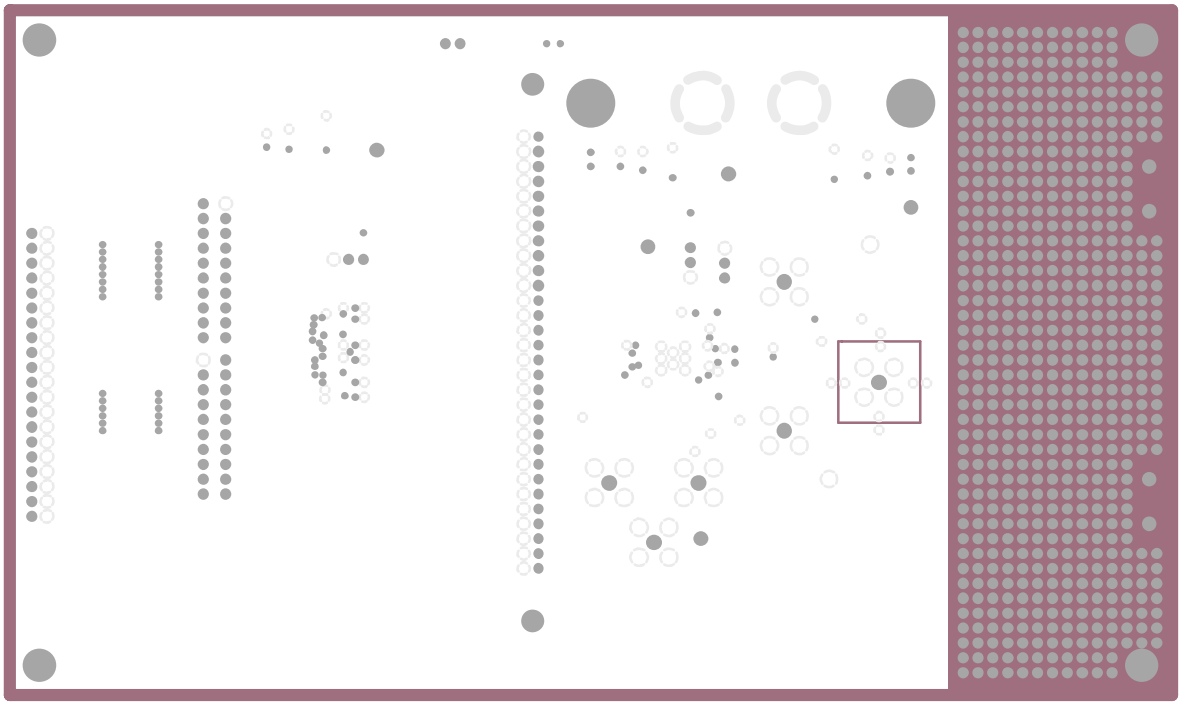
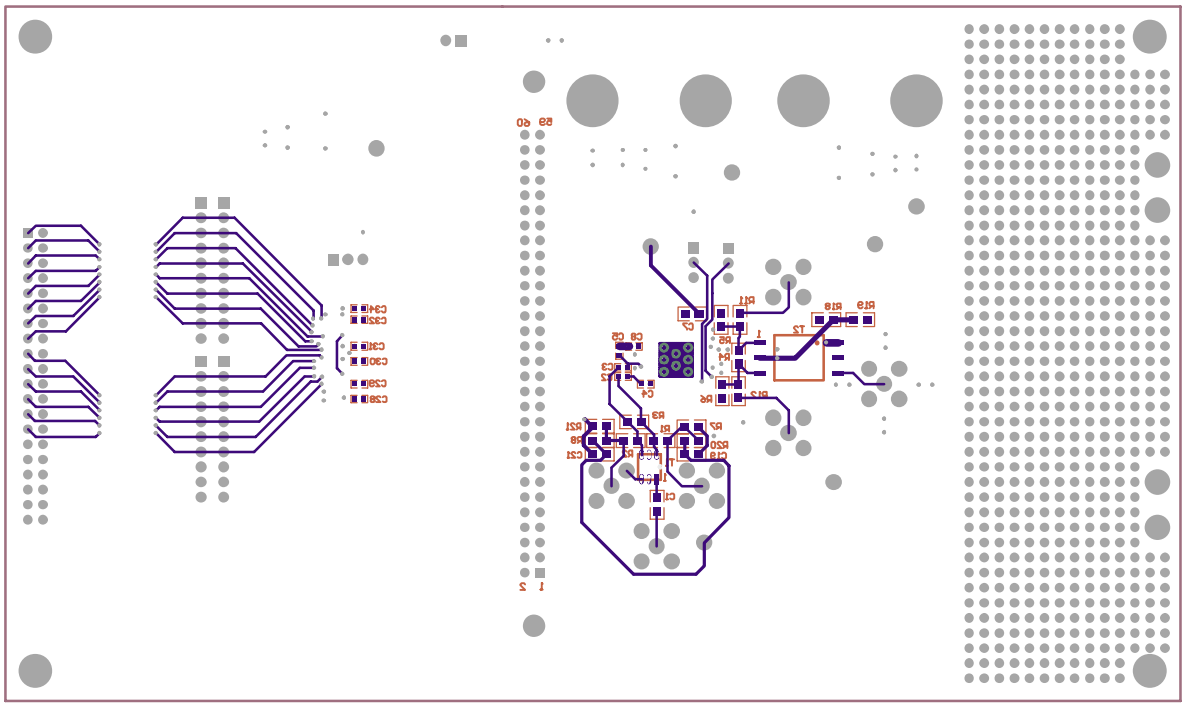


Figure 2−6. Bottom Layer 6



2.2 Parts List

Table 2–1 lists the parts used in constructing the EVM.

Table 2–1. DAC5675A EVM Parts List

Bill Of Material For DAC5675A					
Description	**Qty**	**Part Number**	**Manufacturer**	**Ref Des**	**Not Installed**
0.01-μF, 16 V, 10% capacitor	12	ECJ–1VB1C103K	Panasonic	C8–C13 C28–C32 C34	C4 C5
0.1-μF, 16 V, 10% capacitor	1	ECJ–1VB1C104K	Panasonic	C18	
0.1-μF, 16 V, 10% capacitor	4	ECJ–2VB1C104K	Panasonic	C7 C20 C24 C27	C19 C21
0.01-μF, 50 V, 10% capacitor	1	ECU–V1H103KBG	Panasonic	C1	C6
10-μF, 10 V, 10% capacitor	3	GRM42X5R106K10	Murata	C16 C33 C37	
47-μF, 10 V, 10% capacitor	3	10TPA47M	Sanyo	C14 C15 C17	
0-Ω resistor	30	ERJ–3EKF0R00V	Panasonic	R9 R10 R14 R17 R22–R45	
0-Ω resistor	5	ERJ–6GEY0R00V	Panasonic	R18 C22 C23 C25 C26	R1 R2 R11 R12
10-KΩ resistor	1	CRCW08051002F	Dale	R13	
49.9-Ω resistor	2	CRCW080549R9F	Dale	R5 R6	R7 R8 R20 R21
100-Ω resistor	1	CRCW08051000F	Dale	R4	
1K-Ω resistor	1	ERJ–3EKF1001	Panasonic	R46	
1-kΩ resistor	1	CRCW08051001F	Dale	R15	R16 R19
200-Ω resistor	1	CRCW08052000F	Dale	R3	
22-Ω resistor pack	2	4816P–001–220	Bourns	RP4 RP5	
100-Ω resistor pack	0	EXB–F10E101G	Panasonic		RP1 RP6
51.1-Ω resistor pack	2	770–101–R51	CTS		RP2 RP3
Ferrite bead	3	D01608C–472	Coil Craft	FB1 FB2 FB3	

Table 2−1. DAC5675A EVM Parts List (Continued)

Bill Of Material For DAC5675A					
Description	**Qty**	**Part Number**	**Manufacturer**	**Ref Des**	**Not Installed**
2POS_JUMPER	1	TSW−150−07−L−S	Samtec	W4	
3POS_JUMPER	3	TSW−150−07−L−S	Samtec	W1 W2 W3	
40PIN_IDC	1	TSW−120−07−L−D	Samtec	P2	
60PIN_3M	1	TSW−130−07−L−D	Samtec	P1	
Red Banana Jack	2	ST−351A	Allied	J1 J3	
Black Banana Jack	2	ST−351B	Allied	J2 J4	
BLACK TESTPOINT	2	5001K	Keystone	TP1 TP2	
RED TESTPOINT	3	5000K	Keystone	TP3 TP4 TP5	
DAC5675A	1	DAC5675AIPHP	TI	U1	
SN65LVDS387	1	SN75LVDS387DGG	TI	U3	
Transformer	1	TCM4−1W	Mini-Circuits	T1	
Transformer	1	T1−1T−KK8	Mini-Circuits	T2	
SMA connectors	2	713−4339	Allied	J8 J9	J5 J6 J10 J11

Chapter 3

Circuit Description

This chapter discusses the various functions on the EVM.

Topic **Page**

3.1 Circuit Function 3-2

3.1 Circuit Function

The following paragraphs describe the functions of individual circuits. Refer to the relevant data sheet for device operating characteristics.

3.1.1 Input Clock

The DAC5675A EVM default operation setting is with a differential input clock sent to the DAC5675A. An external sinewave clock is applied to SMA connector J9 and converted to a differential clock input to the DAC5675A by transformer T1. This input represents a 50-Ω load to the source. In order to preserve the specified performance of the DAC5675A converter, the clock source should feature very low jitter. Optimum clock amplitude is 150 mVpp at the J9 input. Using a clock with a 50% duty cycle will give optimum dynamic performance.

3.1.1.1 Differential ECL/PECL Input Clock

The EVM can be configured for differential ECL/ PECL input clock mode by configuring the board per Table 3−1 and applying the appropriate ECL/PECL common mode voltage at terminal E1 (VTT). Use J10 and J11 to input the external differential ECL/PECL clock signals.

3.1.1.2 Single-Ended Input Clock

The EVM can be configured for single-ended input clock mode by configuring the board per Table 3−1. Use J10 SMA to input the external TTL/CMOS clock signal.

Table 3−1. EVM Clock Configuration

Clock Configuration	Components Installed†	Components Not Installed
Differential (default)	R3, T1, C1, C2 (short), C3 (short)	R1, R2, R7, R8, R20, R21, C4, C5
ECL or PECL	R1, R2, R20, R8, C2, C3	R3, R7, R21, T1, C4, C5, C19, C21
Single ended TTL/CMOS	R1, R7, C5, C2 (short),	R2, R3, R20, T1, C3, C4

† All component values are per the schematic except where shown in parenthesis.

3.1.2 Input Data

The DAC5675A EVM can be configured to accept either 3.3-V CMOS logic level or LVDS logic level input data.

3.1.2.1 CMOS Input Data

The DAC5675A EVM can accept 3.3 V CMOS logic level data inputs. With 0 ohm resistors installed for R9, R10, R14, R17, R22−R45, Jumper W4 installed, and Jumper W3 inserted between pins 2 and 3, CMOS level data present at P2 is converted to LVDS levels by the LVDS driver U3. The DAC5675A features internal 100 ohm resistors eliminating the need for external termination resistors. More information on the data inputs can be found in the data sheet. 14-bit CMOS input data is brought in through the 40 pin header P2 per Table 3−2.

Table 3−2. CMOS Input Connector P2

P2 pin	Description	P2 pin	Description
1	CMOS data bit 13 (MSB)	21	CMOS data bit 3
2	GND	22	GND
3	CMOS data bit 12	23	CMOS data bit 2
4	GND	24	GND
5	CMOS data bit 11	25	CMOS data bit 1
6	GND	26	GND
7	CMOS data bit 10	27	CMOS data bit 0 (LSB)
8	GND	28	GND
9	CMOS data bit 9	29	
10	GND	30	GND
11	CMOS data bit 8	31	
12	GND	32	GND
13	CMOS data bit 7	33	
14	GND	34	GND
15	CMOS data bit 6	35	
16	GND	36	GND
17	CMOS data bit 5	37	
18	GND	38	GND
19	CMOS data bit 4	39	
20	GND	40	GND

3.1.2.2 LVDS Input Data

The DAC5675A EVM can accept LVDS (low voltage differential signaling) data inputs per TIA/EIA−644 standard compliant electrical interface. For this mode of operation, R9, R10, R14, R17, R22−R45, and Jumper W4 should be removed for optimal operation. 14-bit input data is brought in through the 60 pin header P1 per Table 3−3.

Table 3−3. LVDS Input Connector P2

P1 Pin	Description	P1 Pin	Description
1	LVDS negative data bit 0 (LSB)	31	
2	GND	32	GND
3	LVDS positive data bit 0 (LSB)	33	LVDS negative data bit 7
4	GND	34	GND
5	LVDS negative data bit 1	35	LVDS positive data bit 7
6	GND	36	GND
7	LVDS positive data bit 1	37	LVDS negative data bit 8
8	GND	38	GND
9	LVDS negative data bit 2	39	LVDS positive data bit 8
10	GND	40	GND
11	LVDS positive data bit 2	41	LVDS negative data bit 9
12	GND	42	GND
13	LVDS negative data bit 3	43	LVDS positive data bit 9
14	GND	44	GND
15	LVDS positive data bit 3	45	LVDS negative data bit 10
16	GND	46	GND
17	LVDS negative data bit 4	47	LVDS positive data bit 10
18	GND	48	GND
19	LVDS positive data bit 4	49	LVDS negative data bit 11
20	GND	50	GND
21	LVDS negative data bit 5	51	LVDS positive data bit 11
22	GND	52	GND
23	LVDS positive data bit 5	53	LVDS negative data bit 12
24	GND	54	GND
25	LVDS negative data bit 6	55	LVDS positive data bit 12
26	GND	56	GND
27	LVDS positive data bit 6	57	LVDS negative data bit 13 (MSB)
28	GND	58	GND
29		59	LVDS positive data bit 13 (MSB)
30	GND	60	GND

3.1.3 Output Data

The DAC5675A EVM can be configured to drive a doubly terminated 50-Ω cable or provide unbuffered differential outputs.

3.1.3.1 Transformer Coupled Signal Output

The factory-set configuration of the demonstration board provides the user with a single-ended output signal at SMA connector J8. The DAC5675A is configured to drive a doubly terminated 50-Ω cable using a 1:1 impedance ratio transformer, a 100-Ω terminating resistor R4, and the center tap of T2 connected to AV_{DD} per Table 3−4. When using a 4:1 impedance ratio transformer, configure the EVM per Table 3−4.

Table 3−4. Transformer Output Configuration

Configuration	Components Installed†	Components Not Installed
1:1 Impedance ratio transformer	R4, R5, R6, R18,C18 T2 (1:1)	R11, R12, R19
4:1 Impedance ratio transformer	R18, R5 (100), R6 (100), C18, T2 (4:1)	R4, R11, R12, R19

† All component values are per the schematic except where shown in parenthesis.

3.1.3.2 Unbuffered Differential Output

To provide unbuffered differential outputs, the EVM must be configured as follows: Remove R4 and T2; Install R11, R12, J5 and J6; Replace R5 and R6 with 25-Ω resistors.

3.1.4 Internal Reference Operation

The full-scale output current is set by applying an external resistor (R15) between the BIASJ pin of the DAC5675A and ground. The full-scale output current can be adjusted from 20 mA down to 2 mA by varying R15 or changing the externally applied reference voltage. The full-scale output current, $IOUT_{FS}$, is defined as follows:

$$IOUT_{FS} = 16 \times \left(\frac{V_{EXTIO}}{R15} \right)$$

where V_{EXTIO} is the voltage at pin EXTIO. This voltage is 1.2 V typical when using the internally provided bandgap reference voltage source.

3.1.5 External Reference Operation

The internal reference can be disabled and overridden by an external reference by connecting a voltage source to terminal E2 (EXT_I/O). The specified range for external reference voltages should be observed (see the DAC5675A data sheet for details).

3.1.6 Sleep Mode

The DAC5675A EVM provides a means of placing the DAC5675A into a power-down mode. This mode is activated by placing Jumper W1 between pins 1 and 2.

Chapter 4

Schematics

This chapter contains the EVM schematic diagrams.

Revision History		
REV	ECN Number	Approved

J1 BANANA_JACK +3.3VA — FB2 — C33 10uF, C14 47uF, C20 .1uF — TP3 RED AVDD

J2 BANANA_JACK

(INSTALLED) FB1 — W4 — +3.3LVD — C16 10uF, C17 47uF, C27 .1uF — TP4 RED +3.3LVD

J3 BANANA_JACK +3.3VD — FB3 — C37 10uF, C15 47uF, C24 .1uF — TP5 RED DVDD

J4 BANANA_JACK

J5 SMA (Note 1) — R11 (Note 1) 0 — R5 49.9 AVDD

T2 T1-1T-KK81 — R18 0 Ohm AVDD — R4 100

J8 SMA — C18 .1uF, R19 1K (Note 1), R12 0 (Note 1), R6 49.9 AVDD

J6 SMA (Note 1)

C11 .01uF, C12 .01uF, C13 .01uF AVDD

E2 EXT_I/O — C7 .1uF — C6 .01uF (Note 1) — R16 1K, R15 1K (Note 1)

W2 — DVDD — R13 10K — SLEEP MODE — E1 VTT

W1 (2-3) — H = SLEEP, L = OPERATE

C19 .1uF (Note 1) — VTT — R20 49.9 (Note 1) — R7 49.9 (Note 1) — J10 SMA (Note 1)

R1 0 Ohm (Note 1)

(D7A..D13A) (D7B..D13B)

P1 — 60PIN_3M

D13A D13B D12A D12B D11A D11B D10A D10B D9A D9B D8A D8B D7A D7B

D6A D6B D5A D5B D4A D4B D3A D3B D2A D2B D1A D1B D0A D0B

(D0A..D6A) (D0B..D6B)

U1 DAC5675A

48	47	46	45	44	43	42	41	40	39	38	37	1	2	3	4	5	6	7	8	9	10	11	12
AVDD	AGND	AGND	AVDD	IOUT2	IOUT1	AVDD	AGND	EXTIO	BIASJ	N/C	SLEEP	D13A	D13B	D12A	D12B	D11A	D11B	D10A	D10B	D9A	D9B	D8A	D8B

36	35	34	33	32	31	30	29	28	27	26	25	13	14	15	16	17	18	19	20	21	22	23	24
D0B	D0A	D1B	D1A	D2B	D2A	D3B	D3A	D4B	D4A	D5B	D5A	D7A	D7B	DVDD	DGND	DVDD	DGND	AGND	AVDD	CLKC	CLK	D6A	D6B

TP1 BLACK, TP2 BLACK

DVDD: C8 .01uF, C9 .01uF

AVDD: C10 .01uF, C4 .01uF (Note 1), C5 .01uF (Note 1), C2 .01uF (Note 2), C3 .01uF (Note 2)

R3 200

(Note 2) C22 .1uF, C23 .1uF, C25 .1uF, C26 .1uF

INPUT CLOCK J9 SMA — C1 .01uF — T1 — TCM4-1W

J11 SMA (Note 1) — R2 0 Ohm (Note 1)

(Note 1) R8 49.9, R21 49.9 (Note 1) — VTT — C21 .1uF (Note 1)

NOTE 1. PART IS NOT INSTALLED

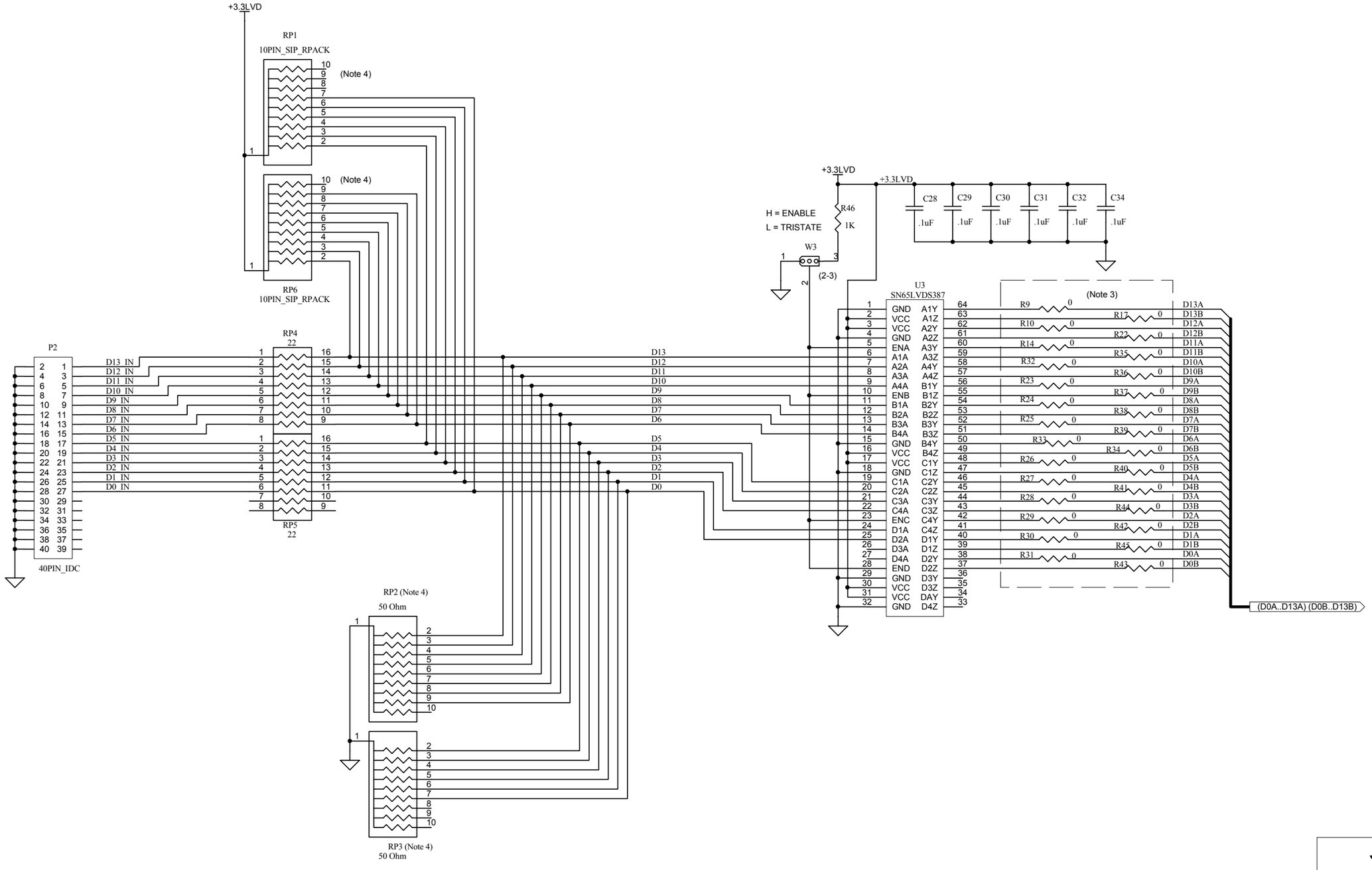
NOTE 2. PART IS REPLACED WITH A SHORT

TEXAS INSTRUMENTS

12500 TI Boulevard. Dallas, Texas 75243

Title: DAC5675 SCHEMATIC

Engineer: JIM SETON	DOCUMENTCONTROL # 6435814		REV: B
Drawn By: Y. DEWONCK			
FILE: 6435814_REVB_SH1.SCH	DATE: 29-Mar-2005	SIZE:	SHEET: 1 OF: 2



NOTE 3: REMOVE 0 OHM RESISTORS WHEN USING P1 FOR INPUT DATA

NOTE 4: PART IS NOT INSTALLED

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Drawn By: Y. DEWONCK	
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DOCUMENTCONTROL #	6435814
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SHEET: 2	OF: 2